

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	359	((@ad<"20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ((second adj adhesive) or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface))))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 13:03
L4	136	!3 and ((second or adhesive or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or nterface)))) with (temperature or degree)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 13:04
L5	59	!3 and ((cur\$3 or second or adhesive or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface)))) near (temperature or degree)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 13:05
L6	17	!5 and (partial or b\$2stage)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 13:52
L7	2	((@ad<"20020508") and (438/457.ccls. or 257/178,418,669.ccls.) and (MCM or multi\$chip or stack) and ((second adj adhesive) or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface))))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 14:02
L8	68	((@ad<"20020508") and (438/457.ccls. or 257/178,418,669.ccls.) and (MCM or multi\$chip or stack)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 14:02
L9	4	!8 and ((partial or b\$2stage or cur\$3 or second or adhesive or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface)))) near (temperature or degree)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 14:03
L10	596	((@ad<"20020508") and ("438"/\$.ccls. or "257"/\$.ccls.) and (mcm or multi\$2chip or stack) and ((second adj adhesive) or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface))))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 14:05
L11	59	!10 and ((partial or b\$2stage or cur\$3 or second or adhesive or "tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface)))) near (temperature or degree)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/19 14:05

S1	1	("5854507").PN.	USPAT; USOCR	OR	OFF	2009/02/18 17:30
S2	7	("20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ((adhere\$3 or adhesive or bond\$3) with temperature)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:08
S3	0	("20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ("tim" or (thermal adj interface))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:10
S4	57	(@ad<"20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ("tim" or (thermal adj interface))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:11
S5	155	(@ad<"20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ("tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface))))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:15
S6	121	S5 and (temperature or degree)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:36
S7	3	S5 and ((temperature or degree) near epoxy)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 18:43
S8	155	(@ad<"20020508") and (438/109,110,118,119.ccls. or 257/686,777,778,783,787,789,790.ccls.) and ("tim" or (thermal adj (adhesiv\$3 or bond\$3 or interface))))	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 23:06
S9	22	S8 and ((temperature or degree) with epoxy)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 23:06
S10	0	S8 and ((temperature or degree) with polyimide)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/18 23:08

S11	6	S8 and ((temperature or degree) with polyimide)	US-PGRUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_ TDB	OR	OFF	2009/02/18 23:08
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2/19/2009 2:06:41 PM